



50V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
	2Ω @ V _{GS} = 5V	350mA
50V	2.5Ω @ V _G S = 2.5V	330mA
	4Ω @ V _G S = 1.8V	270mA

Features and Benefits

- Low On-Resistance
- Very Low Gate Threshold Voltage (1.0V max)
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (DMN52D0UDWQ)

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Load switches
- Level switches

Mechanical Data

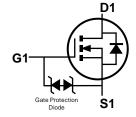
- Package: SOT363
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)

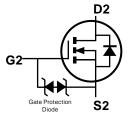


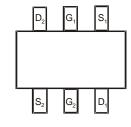


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Equivalent Circuit

Top View Pinout

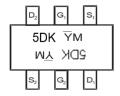
Ordering Information (Note 4)

Part Number	Backago	Packing		
Part Number	Package	Qty.	Carrier	
DMN52D0UDW-7	SOT363	3,000	Reel	
DMN52D0UDW-13	SOT363	10,000	Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\underline{5}$ DK = Product Type Marking Code \overline{Y} M = Date Code Marking \overline{Y} = Year (ex: L = 2024) M = Month (ex: 9 = September)

Date Code Key

Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	М	N	Р	R	S	Т	U	V	W	Χ
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	50	V	
Gate-Source Voltage		V_{GSS}	±12	V	
Continuous Drain Current (Note 6) VGS = 5V	lD	350 280	mA		
Maximum Continuous Body Diode Forward Curi	ent (Note 6)	Is	350	mA	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		IDM	1.2	Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	373	°C/W
Total Power Dissipation (Note 6)		PD	0.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	241	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

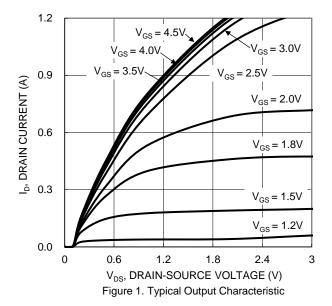
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	50	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	$V_{DS} = 50V$, $V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 12V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	0.49		1.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		_	1.6	4.0		$V_{GS} = 1.8V, I_D = 50mA$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.2	2.5	Ω	$V_{GS} = 2.5V, I_D = 50mA$
		_	1.0	2.0		$V_{GS} = 5.0V, I_{D} = 50mA$
Diode Forward Voltage	VsD	_	0.6	1.2	V	$V_{GS} = 0V$, $I_D = 50mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	42.3	_	pF	
Output Capacitance	Coss	_	5.7	_	рF	$V_{DS} = 25V, V_{GS} = 0V$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	4.5	_	pF	1 – 1.011112
Gate Resistance	Rg	_	53	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.7	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.5	_	nC	V _{DS} = 25V. I _D = 50mA
Gate-Source Charge	Qgs	_	0.1	_	nC	VDS = 25V, ID = 50HIA
Gate-Drain Charge	Q_{gd}	_	0.2	_	nC	
Turn-On Delay Time	td(on)	_	1.1	_	ns	
Turn-On Rise Time	t _R	_	8.3	_	ns	$V_{DS} = 25V, V_{GS} = 10V,$
Turn-Off Delay Time	tD(OFF)	_	31	_	ns	$R_G = 50\Omega$, $I_D = 50mA$
Turn-Off Fall Time	tF		41	_	ns	

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing.





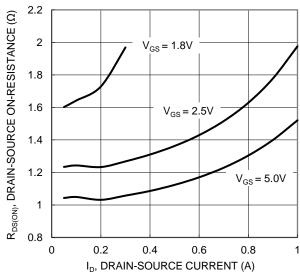


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

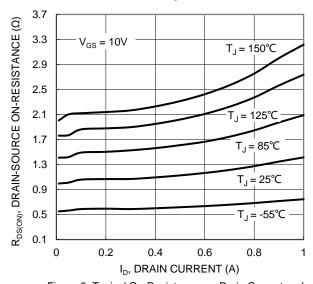
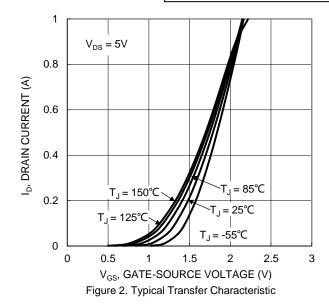
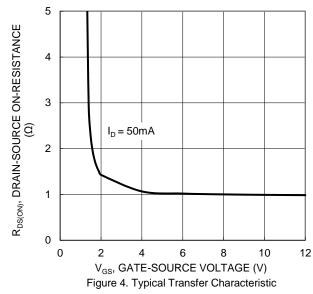


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





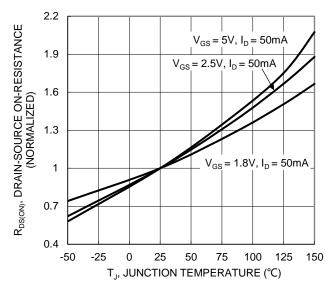


Figure 6. On-Resistance Variation with Temperature





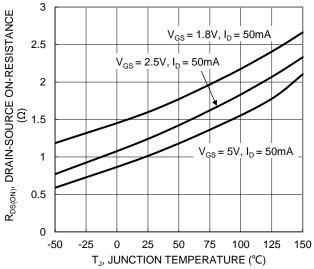


Figure 7. On-Resistance Variation with Temperature

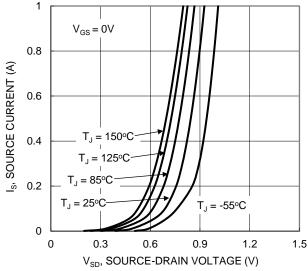


Figure 9. Diode Forward Voltage vs. Current

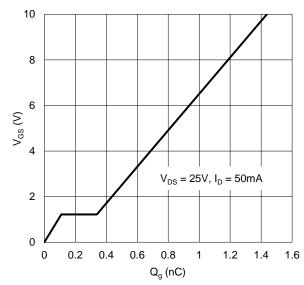


Figure 11. Gate Charge

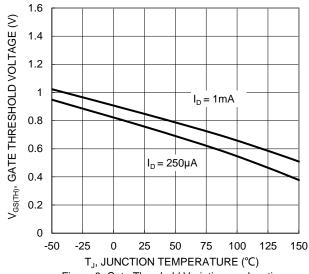


Figure 8. Gate Threshold Variation vs. Junction Temperature

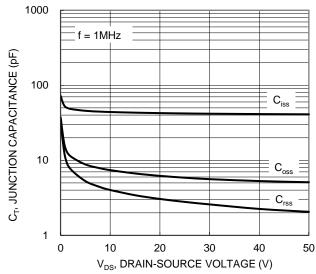


Figure 10. Typical Junction Capacitance

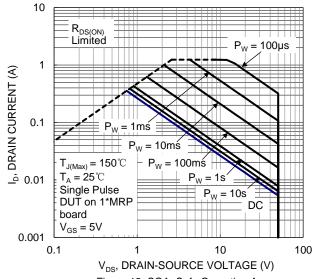


Figure 12. SOA, Safe Operation Area



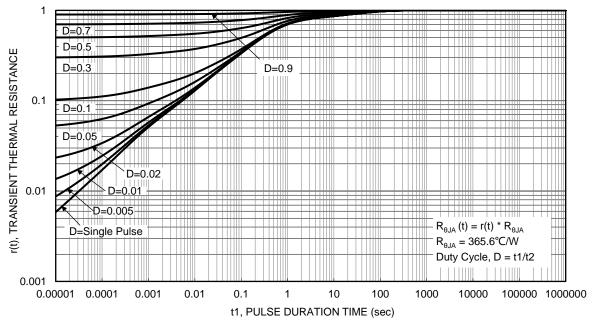


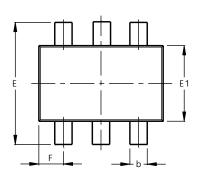
Figure 13. Transient Thermal Resistance

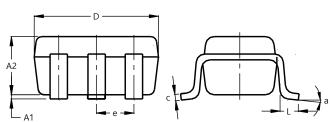


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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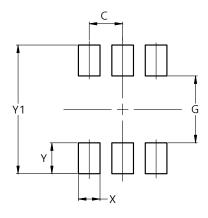


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
E	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
Х	0.420
Y	0.600
V1	2 500



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